

July 2007

## EGP10A - EGP10K

# 1.0 Ampere Glass Passivated High Efficiency Rectifiers

### **Features**

- Superfast recovery time for high efficiency
- Low forward voltage, high current capability
- · Low leakage current
- High surge current capability



**DO-41 Glass case**COLOR BAND DENOTES CATHODE

## Absolute Maximum Ratings\* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
I <sub>O</sub>	Average Rectified Current .375 " lead length @ TL = 75°C	1.0	А
i <sub>f(surge)</sub>	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	30	А
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	2.5 17	W mW°C
I <sub>C</sub>	Thermal Resistance, Junction to Ambient	50	°C/W
T <sub>J</sub> , T <sub>STG</sub>	Junction and Storage Temperature Range	-65 ~ 150	°C

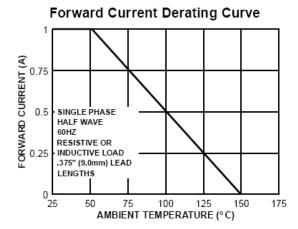
<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

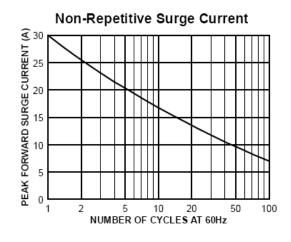
## Electrical Characteristics\* T<sub>a</sub> = 25°C unless otherwise noted

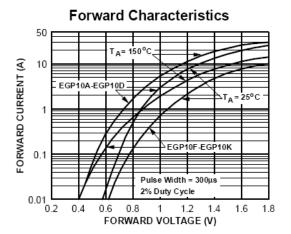
	Device								
Parameter	10A	10B	10C	10D	10F	10G	10J	10K	Units
Peak Repetitive Reverse Voltage	50	100	150	200	300	400	600	800	V
Maximum RMS Voltage	35	70	105	140	210	280	420	560	V
DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	150	200	300	400	600	800	V
Maximum Reverse Current @ rated VR TA = 25°C TA = 125°C	5.0 100								μ <b>Α</b> μ <b>Α</b>
Maximum Reverse Recovery Time IF = 0.5 A, IR = 1.0 A, Irr = 0.25 A	50 75							nS	
Maximum Forward Voltage @ 1.0 A	0.95				1.25		1	.7	V
Typical Junction Capacitance VR = 4.0 V, f = 1.0 MHz	22 15						pF		

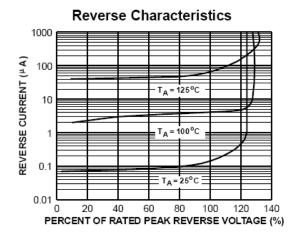
<sup>\*</sup> Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

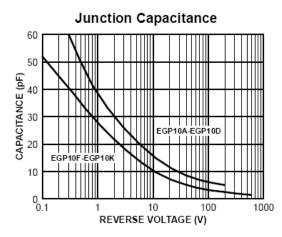
## **Typical Performance Characteristics**





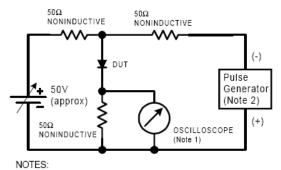




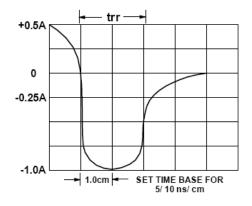


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## **Reverse Recovery Time Characterstic and Test Circuit Diagram**



- 1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.
- 2. Rise time = 10 ns max; Source impedance = 50 ohms.







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